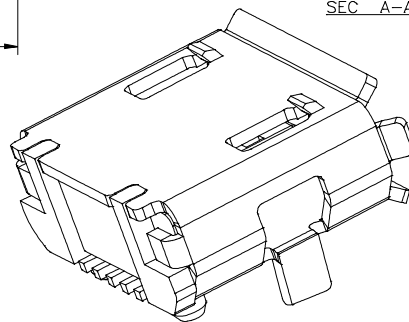
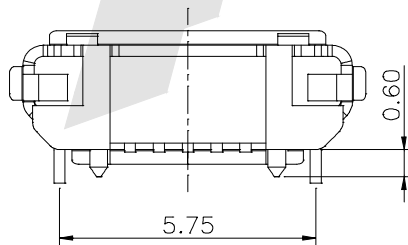
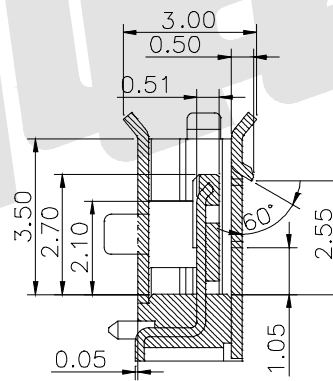
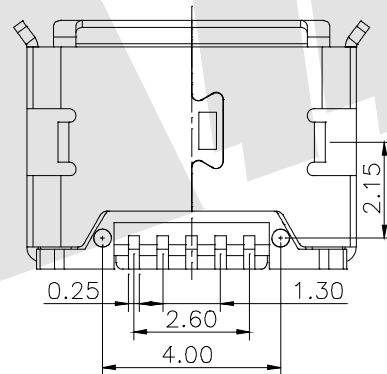
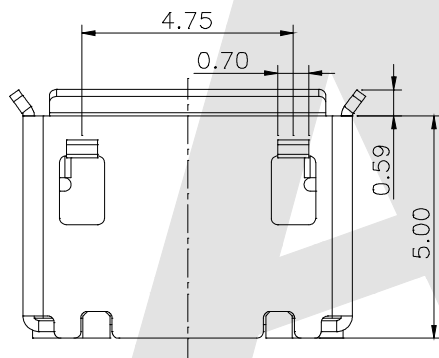
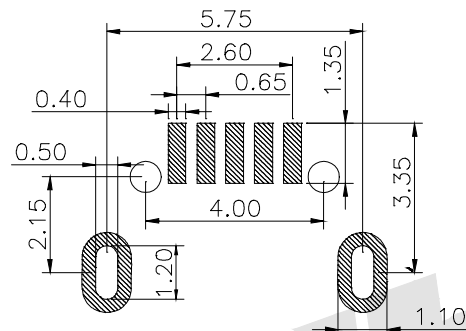
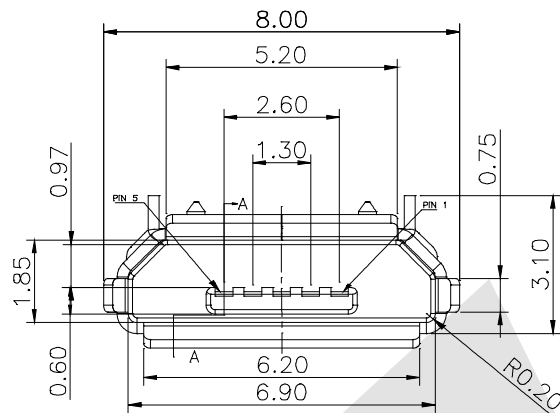




Notes:

1. Materials:

- 1.1Housing:High temperature thermoplastic with g, f UL94V-0
- 1.2 Contact copper alloy t=0.15mm
- 1.3Shell: copper alloy t=0.30mm

2. Specifications:

- 2.1 Current rating:1A Max
- 2.2 Dielectric withstanding voltage:100v(ac) for 1min
- 2.3 Contact resistance:50mΩ Max
- 2.4 Insulation resistance:100MΩ Min
- 2.5 Total mating force:3.57Kgf Max
- 2.6 Total unmating force:1.0Kgf Min 0.81-2.05Kgf Min.after 10000 insertion extration cycles
- 2.7 Temperature rang :-30℃ TO +80℃

Order code:

MUFM16 - X - X - X - X - X

① ② ③ ④ ⑤ ⑥

① Series NO:

② Shell Material:
B:Brass I:Iron
S:stainless steel

③ Insulator Material:
P:PBT+30%GF
L:LCP

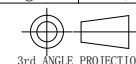
④ Contact Material:
B:Brass
P:phosphor copper

⑤ Contact Plating
G0:Gold flash
G1: 3U" Gold
G2: 5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold

⑥ Packing
A:Tray
B:Bag
C:Tube
D:Tape & Reel

Unless Otherwise specified tolerance
X. ±0.35 X.XX:±0.20
X.X:±0.25 X.XXX:±0.15

SCALE: As Shown	UNIT: mm
DRAW Lv Xun Hua	DATE 01/06/2019
CHECK BobYang	DATE 01/06/2019



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Http://www.antenk.com
E-mail:sales@antenk.com

TITLE:
MICRO USB SMT 5P RECEPTACLE B TYPE,
Shell dip with Post

DRAWING NO: MUFM16-XXXXX

PRODUCT NO: MUFM16-XXXXX

REV	DESCRIPTION	DATE
1		
2		
3		
4		
5		